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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf873at-i-ml

FIGURE 2-3: **PIC16F876A/877A REGISTER FILE MAP**

	File Address		File Address		File Address		File Address
Indirect addr.(*)	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*)	180h
TMR0	01h	OPTION_REG	81h	TMR0	101h	OPTION_REG	181h
PCL	02h	PCL	82h	PCL	102h	PCL	182h
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	183h
FSR	04h	FSR	84h	FSR	104h	FSR	184h
PORTA	05h	TRISA	85h		105h		185h
PORTB	06h	TRISB	86h	PORTB	106h	TRISB	186h
PORTC	07h	TRISC	87h		107h		187h
PORTD(1)	08h	TRISD(1)	88h		108h		188h
PORTE(1)	09h	TRISE(1)	89h		109h		189h
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18Ah
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18Bh
PIR1	0Ch	PIE1	8Ch	EEDATA	10Ch	EECON1	18Ch
PIR2	0Dh	PIE2	8Dh	EEADR	10Dh	EECON2	18Dh
TMR1L	0Eh	PCON	8Eh	EEDATH	10Eh	Reserved(2)	18Eh
TMR1H	0Fh		8Fh	EEADRH	10Fh	Reserved(2)	18Fh
T1CON	10h		90h		110h		190h
TMR2	11h	SSPCON2	91h		111h		191h
T2CON	12h	PR2	92h		112h		192h
SSPBUF	13h	SSPADD	93h		113h		193h
SSPCON	14h	SSPSTAT	94h		114h		194h
CCPR1L	15h		95h		115h		195h
CCPR1H	16h		96h		116h		196h
CCP1CON	17h		97h	General Purpose Register 16 Bytes	117h	General Purpose Register 16 Bytes	197h
RCSTA	18h	TXSTA	98h		118h		198h
TXREG	19h	SPBRG	99h		119h		199h
RCREG	1Ah		9Ah		11Ah		19Ah
CCPR2L	1Bh		9Bh		11Bh		19Bh
CCPR2H	1Ch	CMCON	9Ch		11Ch		19Ch
CCP2CON	1Dh	CVRCON	9Dh		11Dh		19Dh
ADRESH	1Eh	ADRESL	9Eh		11Eh		19Eh
ADCON0	1Fh	ADCON1	9Fh		11Fh		19Fh
	20h		A0h		120h		1A0h
General Purpose Register 96 Bytes		General Purpose Register 80 Bytes		General Purpose Register 80 Bytes		General Purpose Register 80 Bytes	
			EFh		16Fh		1EFh
		accesses 70h-7Fh	F0h	accesses 70h-7Fh	170h	accesses 70h - 7Fh	1F0h
	7Fh		FFh		17Fh		1FFh
Bank 0		Bank 1		Bank 2		Bank 3	

☐ Unimplemented data memory locations, read as '0'.

* Not a physical register.

Note 1: These registers are not implemented on the PIC16F876A.

2: These registers are reserved; maintain these registers clear.

2.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. A list of these registers is given in Table 2-1.

The Special Function Registers can be classified into two sets: core (CPU) and peripheral. Those registers associated with the core functions are described in detail in this section. Those related to the operation of the peripheral features are described in detail in the peripheral features section.

TABLE 2-1: SPECIAL FUNCTION REGISTER SUMMARY

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page:
Bank 0											
00h[3]	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	31, 150
01h	TMR0	Timer0 Module Register								xxxx xxxx	55, 150
02h[3]	PCL	Program Counter (PC) Least Significant Byte								0000 0000	30, 150
03h[3]	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	22, 150
04h[3]	FSR	Indirect Data Memory Address Pointer								xxxx xxxx	31, 150
05h	PORTA	—	—	PORTA Data Latch when written: PORTA pins when read						--0x 0000	43, 150
06h	PORTB	PORTB Data Latch when written: PORTB pins when read								xxxx xxxx	45, 150
07h	PORTC	PORTC Data Latch when written: PORTC pins when read								xxxx xxxx	47, 150
08h[4]	PORTD	PORTD Data Latch when written: PORTD pins when read								xxxx xxxx	48, 150
09h[4]	PORTE	—	—	—	—	—	RE2	RE1	RE0	---- -xxx	49, 150
0Ah[1,3]	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	30, 150
0Bh[3]	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	24, 150
0Ch	PIR1	PSPIF[3]	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	26, 150
0Dh	PIR2	—	CMIF	—	EEIF	BCLIF	—	—	CCP2IF	-0-0 0--0	28, 150
0Eh	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	60, 150
0Fh	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	60, 150
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{T1SYNC}$	TMR1CS	TMR1ON	--00 0000	57, 150
11h	TMR2	Timer2 Module Register								0000 0000	62, 150
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	61, 150
13h	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register								xxxx xxxx	79, 150
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	82, 82, 150
15h	CCPR1L	Capture/Compare/PWM Register 1 (LSB)								xxxx xxxx	63, 150
16h	CCPR1H	Capture/Compare/PWM Register 1 (MSB)								xxxx xxxx	63, 150
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	64, 150
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	112, 150
19h	TXREG	USART Transmit Data Register								0000 0000	118, 150
1Ah	RCREG	USART Receive Data Register								0000 0000	118, 150
1Bh	CCPR2L	Capture/Compare/PWM Register 2 (LSB)								xxxx xxxx	63, 150
1Ch	CCPR2H	Capture/Compare/PWM Register 2 (MSB)								xxxx xxxx	63, 150
1Dh	CCP2CON	—	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	--00 0000	64, 150
1Eh	ADRESH	A/D Result Register High Byte								xxxx xxxx	133, 150
1Fh	ADCON0	ADCS1	ADCS0	CHS2	CHS1	CHS0	$\overline{GO/DONE}$	—	ADON	0000 00-0	127, 150

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8>, whose contents are transferred to the upper byte of the program counter.

2: Bits PSPIE and PSPIF are reserved on PIC16F873A/876A devices; always maintain these bits clear.

3: These registers can be addressed from any bank.

4: PORTD, PORTE, TRISD and TRISE are not implemented on PIC16F873A/876A devices, read as '0'.

5: Bit 4 of EEADRH implemented only on the PIC16F876A/877A devices.

TABLE 8-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF[(1)]	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	—	—	—	—	—	—	—	CCP2IF	---- ---0	---- ---0
8Ch	PIE1	PSPIE[(1)]	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh	PIE2	—	—	—	—	—	—	—	CCP2IE	---- ---0	---- ---0
87h	TRISC	PORTC Data Direction Register								1111 1111	1111 1111
11h	TMR2	Timer2 Module's Register								0000 0000	0000 0000
92h	PR2	Timer2 Module's Period Register								1111 1111	1111 1111
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
15h	CCPR1L	Capture/Compare/PWM Register 1 (LSB)								xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Compare/PWM Register 1 (MSB)								xxxx xxxx	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	--00 0000
1Bh	CCPR2L	Capture/Compare/PWM Register 2 (LSB)								xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Compare/PWM Register 2 (MSB)								xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	—	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	--00 0000	--00 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by PWM and Timer2.

Note 1: Bits PSPIE and PSPIF are reserved on 28-pin devices; always maintain these bits clear.

**REGISTER 9-2:**   **SSPCON1: MSSP CONTROL REGISTER 1 (SPI MODE) (ADDRESS 14h)**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0

bit 7   bit 0

bit 7   **WCOL:** Write Collision Detect bit (Transmit mode only)

                1 = The SSPBUF register is written while it is still transmitting the previous word. (Must be cleared in software.)

                0 = No collision

bit 6   **SSPOV:** Receive Overflow Indicator bit

                <u>SPI Slave mode:</u>

                1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in Slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. (Must be cleared in software.)

                0 = No overflow

        Note: In Master mode, the overflow bit is not set, since each new reception (and transmission) is initiated by writing to the SSPBUF register.

bit 5   **SSPEN:** Synchronous Serial Port Enable bit

                1 = Enables serial port and configures SCK, SDO, SDI, and $\overline{SS}$ as serial port pins

                0 = Disables serial port and configures these pins as I/O port pins

        Note: When enabled, these pins must be properly configured as input or output.

bit 4   **CKP:** Clock Polarity Select bit

                1 = Idle state for clock is a high level

                0 = Idle state for clock is a low level

bit 3-0   **SSPM3:SSPM0:** Synchronous Serial Port Mode Select bits

                0101 = SPI Slave mode, clock = SCK pin. $\overline{SS}$ pin control disabled. $\overline{SS}$ can be used as I/O pin.

                0100 = SPI Slave mode, clock = SCK pin. $\overline{SS}$ pin control enabled.

                0011 = SPI Master mode, clock = TMR2 output/2

                0010 = SPI Master mode, clock = F_{OSC}/64

                0001 = SPI Master mode, clock = F_{OSC}/16

                0000 = SPI Master mode, clock = F_{OSC}/4

        Note: Bit combinations not specifically listed here are either reserved or implemented in I^{2}C mode only.

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

FIGURE 9-14: I²C SLAVE MODE TIMING SEN = `1` (RECEPTION, 10-BIT ADDRESS)
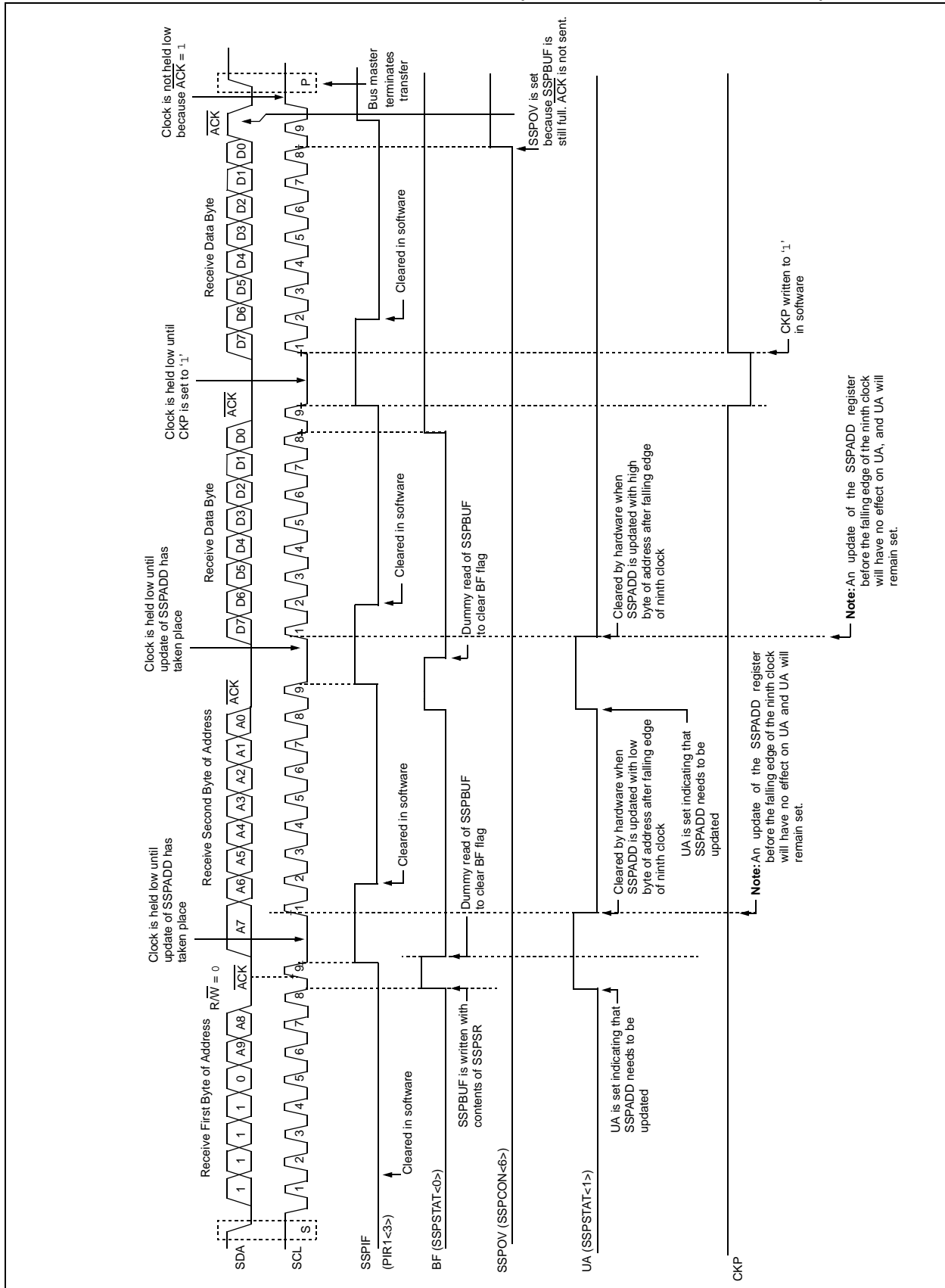
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TABLE 10-3: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD RATE (K)	Fosc = 20 MHz			Fosc = 16 MHz			Fosc = 10 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	-	-	-	-	-	-	-	-	-
1.2	1.221	1.75	255	1.202	0.17	207	1.202	0.17	129
2.4	2.404	0.17	129	2.404	0.17	103	2.404	0.17	64
9.6	9.766	1.73	31	9.615	0.16	25	9.766	1.73	15
19.2	19.531	1.72	15	19.231	0.16	12	19.531	1.72	7
28.8	31.250	8.51	9	27.778	3.55	8	31.250	8.51	4
33.6	34.722	3.34	8	35.714	6.29	6	31.250	6.99	4
57.6	62.500	8.51	4	62.500	8.51	3	52.083	9.58	2
HIGH	1.221	-	255	0.977	-	255	0.610	-	255
LOW	312.500	-	0	250.000	-	0	156.250	-	0

BAUD RATE (K)	Fosc = 4 MHz			Fosc = 3.6864 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	0.300	0	207	0.3	0	191
1.2	1.202	0.17	51	1.2	0	47
2.4	2.404	0.17	25	2.4	0	23
9.6	8.929	6.99	6	9.6	0	5
19.2	20.833	8.51	2	19.2	0	2
28.8	31.250	8.51	1	28.8	0	1
33.6	-	-	-	-	-	-
57.6	62.500	8.51	0	57.6	0	0
HIGH	0.244	-	255	0.225	-	255
LOW	62.500	-	0	57.6	-	0

TABLE 10-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD RATE (K)	Fosc = 20 MHz			Fosc = 16 MHz			Fosc = 10 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	-	-	-	-	-	-	-	-	-
1.2	-	-	-	-	-	-	-	-	-
2.4	-	-	-	-	-	-	2.441	1.71	255
9.6	9.615	0.16	129	9.615	0.16	103	9.615	0.16	64
19.2	19.231	0.16	64	19.231	0.16	51	19.531	1.72	31
28.8	29.070	0.94	42	29.412	2.13	33	28.409	1.36	21
33.6	33.784	0.55	36	33.333	0.79	29	32.895	2.10	18
57.6	59.524	3.34	20	58.824	2.13	16	56.818	1.36	10
HIGH	4.883	-	255	3.906	-	255	2.441	-	255
LOW	1250.000	-	0	1000.000	-	0	625.000	-	0

BAUD RATE (K)	Fosc = 4 MHz			Fosc = 3.6864 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	-	-	-	-	-	-
1.2	1.202	0.17	207	1.2	0	191
2.4	2.404	0.17	103	2.4	0	95
9.6	9.615	0.16	25	9.6	0	23
19.2	19.231	0.16	12	19.2	0	11
28.8	27.798	3.55	8	28.8	0	7
33.6	35.714	6.29	6	32.9	2.04	6
57.6	62.500	8.51	3	57.6	0	3
HIGH	0.977	-	255	0.9	-	255
LOW	250.000	-	0	230.4	-	0

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FIGURE 10-5: **ASYNCHRONOUS RECEPTION**

Note: This timing diagram shows three words appearing on the RX input. The RCREG (Receive Buffer) is read after the third word, causing the OERR (Overrun Error) bit to be set.
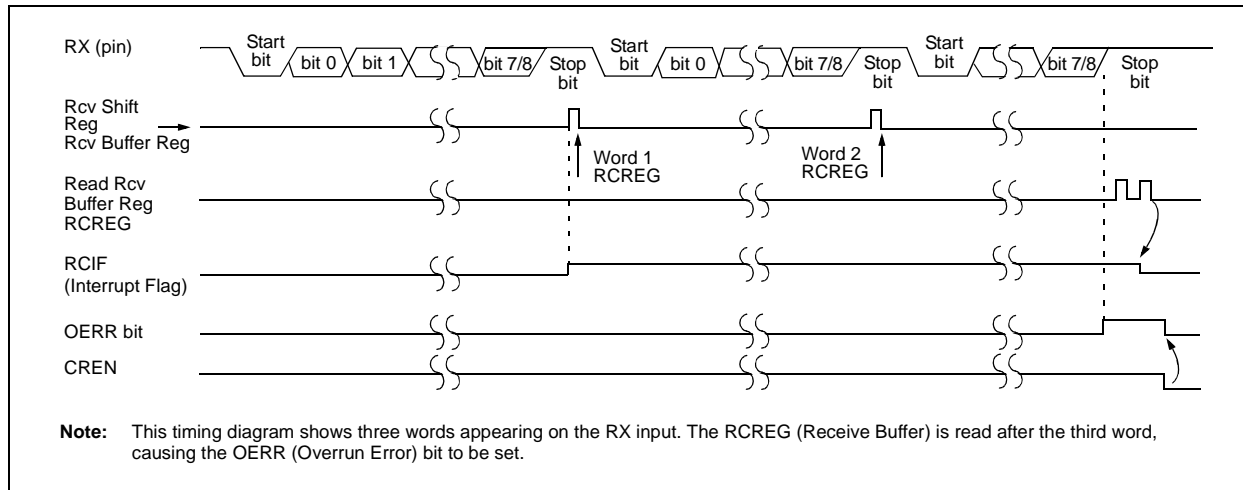
When setting up an Asynchronous Reception, follow these steps:

1. Initialize the SPBRG register for the appropriate baud rate. If a high-speed baud rate is desired, set bit BRGH (**Section 10.1 "USART Baud Rate Generator (BRG)"**).
2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
3. If interrupts are desired, then set enable bit RCIE.
4. If 9-bit reception is desired, then set bit RX9.
5. Enable the reception by setting bit CREN.

6. Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE is set.
7. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
8. Read the 8-bit received data by reading the RCREG register.
9. If any error occurred, clear the error by clearing enable bit CREN.
10. If using interrupts, ensure that GIE and PEIE (bits 7 and 6) of the INTCON register are set.

**TABLE 10-6:** **REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	R0IF	0000 000x	0000 000u
0Ch	PIR1	PSPIF[1]	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART Receive Register								0000 0000	0000 0000
8Ch	PIE1	PSPIE[1]	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.
Note 1: Bits PSPIE and PSPIF are reserved on 28-pin devices; always maintain these bits clear.

FIGURE 10-11:   **SYNCHRONOUS RECEPTION (MASTER MODE, SREN)**

Note: Timing diagram demonstrates Sync Master mode with bit SREN = 1 and bit BRG = 0.
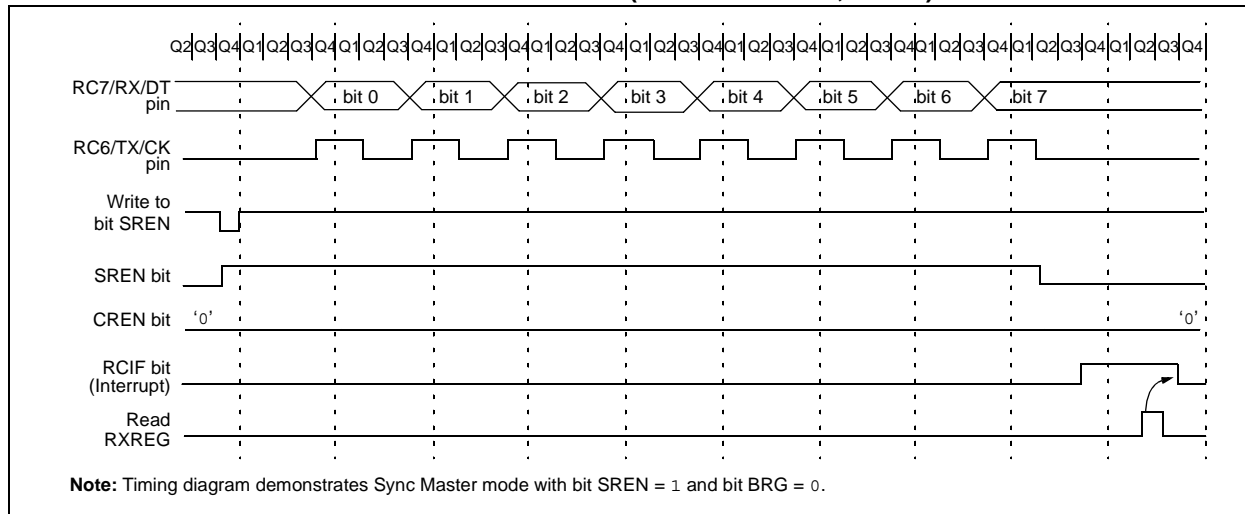
10.4 USART Synchronous Slave Mode

Synchronous Slave mode differs from the Master mode in the fact that the shift clock is supplied externally at the RC6/TX/CK pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in Sleep mode. Slave mode is entered by clearing bit, CSRC (TXSTA<7>).

10.4.1   USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the Synchronous Master and Slave modes is identical, except in the case of the Sleep mode.

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

a)   The first word will immediately transfer to the TSR register and transmit.

b)   The second word will remain in TXREG register.

c)   Flag bit TXIF will not be set.

d)   When the first word has been shifted out of TSR, the TXREG register will transfer the second word to the TSR and flag bit TXIF will now be set.

e)   If enable bit TXIE is set, the interrupt will wake the chip from Sleep and if the global interrupt is enabled, the program will branch to the interrupt vector (0004h).

When setting up a Synchronous Slave Transmission, follow these steps:

1.   Enable the synchronous slave serial port by setting bits SYNC and SPEN and clearing bit CSRC.

2.   Clear bits CREN and SREN.

3.   If interrupts are desired, then set enable bit TXIE.

4.   If 9-bit transmission is desired, then set bit TX9.

5.   Enable the transmission by setting enable bit TXEN.

6.   If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.

7.   Start transmission by loading data to the TXREG register.

8.   If using interrupts, ensure that GIE and PEIE (bits 7 and 6) of the INTCON register are set.

13.0 COMPARATOR VOLTAGE REFERENCE MODULE

The Comparator Voltage Reference Generator is a 16-tap resistor ladder network that provides a fixed voltage reference when the comparators are in mode '110'. A programmable register controls the function of the reference generator. Register 13-1 lists the bit functions of the CVRCON register.

As shown in Figure 13-1, the resistor ladder is segmented to provide two ranges of CVREF values and has a power-down function to conserve power when the reference is not being used. The comparator reference supply voltage (also referred to as CVRSRC) comes directly from VDD. It should be noted, however, that the voltage at the top of the ladder is CVRSRC – VSAT, where VSAT is the saturation voltage of the power switch transistor. This reference will only be as accurate as the values of CVRSRC and VSAT.

The output of the reference generator may be connected to the RA2/AN2/VREF-/CVREF pin. This can be used as a simple D/A function by the user if a very high-impedance load is used. The primary purpose of this function is to provide a test path for testing the reference generator function.

REGISTER 13-1: CVRCON CONTROL REGISTER (ADDRESS 9Dh)

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
CVREN	CVROE	CVRR	—	CVR3	CVR2	CVR1	CVR0

bit 7   bit 0

bit 7   **CVREN**: Comparator Voltage Reference Enable bit

1 = CVREF circuit powered on
0 = CVREF circuit powered down

bit 6   **CVROE:** Comparator VREF Output Enable bit

1 = CVREF voltage level is output on RA2/AN2/VREF-/CVREF pin
0 = CVREF voltage level is disconnected from RA2/AN2/VREF-/CVREF pin

bit 5   **CVRR**: Comparator VREF Range Selection bit

1 = 0 to 0.75 CVRSRC, with CVRSRC/24 step size
0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size

bit 4   **Unimplemented:** Read as '0'

bit 3-0   **CVR3:CVR0:** Comparator VREF Value Selection bits $0 \leq VR3{:}VR0 \leq 15$
When CVRR = 1:
CVREF = (VR<3:0>/ 24) • (CVRSRC)
When CVRR = 0:
CVREF = 1/4 • (CVRSRC) + (VR3:VR0/ 32) • (CVRSRC)

| Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

TABLE 14-6:   INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Devices				Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset	Wake-up via WDT or Interrupt
TRISD	73A	74A	76A	77A	1111 1111	1111 1111	uuuu uuuu
TRISE	73A	74A	76A	77A	0000 -111	0000 -111	uuuu -uuu
PIE1	73A	74A	76A	77A	r000 0000	r000 0000	ruuu uuuu
	73A	74A	76A	77A	0000 0000	0000 0000	uuuu uuuu
PIE2	73A	74A	76A	77A	-0-0 0--0	-0-0 0--0	-u-u u--u
PCON	73A	74A	76A	77A	---- --qq	---- --uu	---- --uu
SSPCON2	73A	74A	76A	77A	0000 0000	0000 0000	uuuu uuuu
PR2	73A	74A	76A	77A	1111 1111	1111 1111	1111 1111
SSPADD	73A	74A	76A	77A	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	73A	74A	76A	77A	--00 0000	--00 0000	--uu uuuu
TXSTA	73A	74A	76A	77A	0000 -010	0000 -010	uuuu -uuu
SPBRG	73A	74A	76A	77A	0000 0000	0000 0000	uuuu uuuu
CMCON	73A	974	76A	77A	0000 0111	0000 0111	uuuu uuuu
CVRCON	73A	74A	76A	77A	000- 0000	000- 0000	uuu- uuuu
ADRESL	73A	74A	76A	77A	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON1	73A	74A	76A	77A	00-- 0000	00-- 0000	uu-- uuuu
EEDATA	73A	74A	76A	77A	xxxx xxxx	uuuu uuuu	uuuu uuuu
EEADR	73A	74A	76A	77A	xxxx xxxx	uuuu uuuu	uuuu uuuu
EEDATH	73A	74A	76A	77A	xxxx xxxx	uuuu uuuu	uuuu uuuu
EEADRH	73A	74A	76A	77A	xxxx xxxx	uuuu uuuu	uuuu uuuu
EECON1	73A	74A	76A	77A	x--- x000	u--- u000	u--- uuuu
EECON2	73A	74A	76A	77A	---- ----	---- ----	---- ----

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition,
r = reserved, maintain clear. Shaded cells indicate conditions do not apply for the designated device.

Note   1:   One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

2:   When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3:   See Table 14-5 for Reset value for specific condition.

FIGURE 14-6:   TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD VIA RC NETWORK)
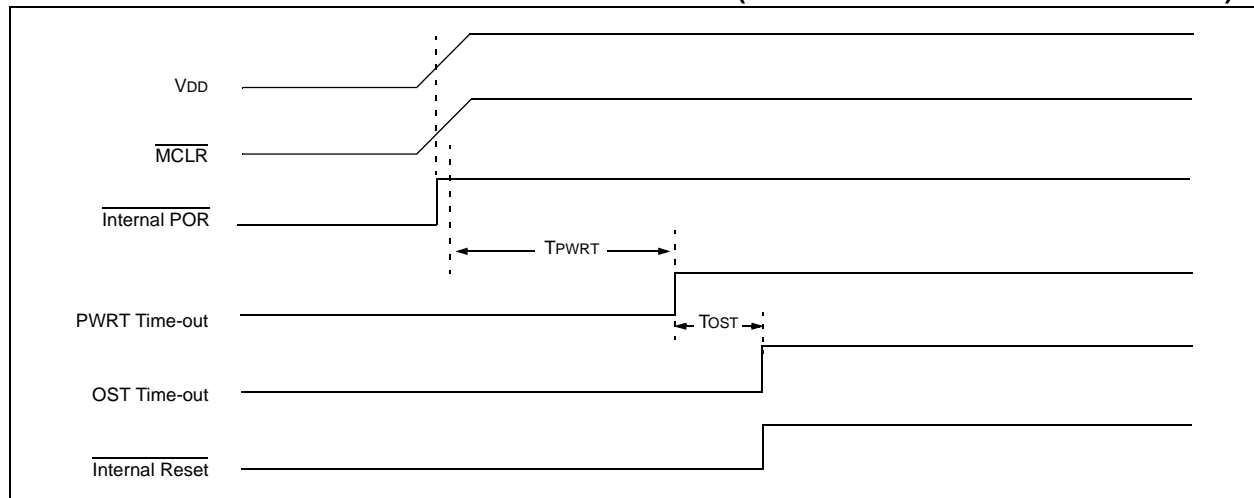
15.0   INSTRUCTION SET SUMMARY

The PIC16 instruction set is highly orthogonal and is comprised of three basic categories:

• **Byte-oriented** operations

• **Bit-oriented** operations

• **Literal and control** operations

Each PIC16 instruction is a 14-bit word divided into an **opcode** which specifies the instruction type and one or more **operands** which further specify the operation of the instruction. The formats for each of the categories is presented in Figure 15-1, while the various opcode fields are summarized in Table 15-1.

Table 15-2 lists the instructions recognized by the MPASM™ Assembler. A complete description of each instruction is also available in the PIC® Mid-Range MCU Family Reference Manual (DS33023).

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the bit affected by the operation, while 'f' represents the address of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven-bit constant or literal value

One instruction cycle consists of four oscillator periods; for an oscillator frequency of 4 MHz, this gives a normal instruction execution time of 1 μs. All instructions are executed within a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of an instruction. When this occurs, the execution takes two instruction cycles with the second cycle executed as a NOP.

Note:	To maintain upward compatibility with future PIC16F87XA products, do not use the OPTION and TRIS instructions.

All instruction examples use the format '0xhh' to represent a hexadecimal number, where 'h' signifies a hexadecimal digit.

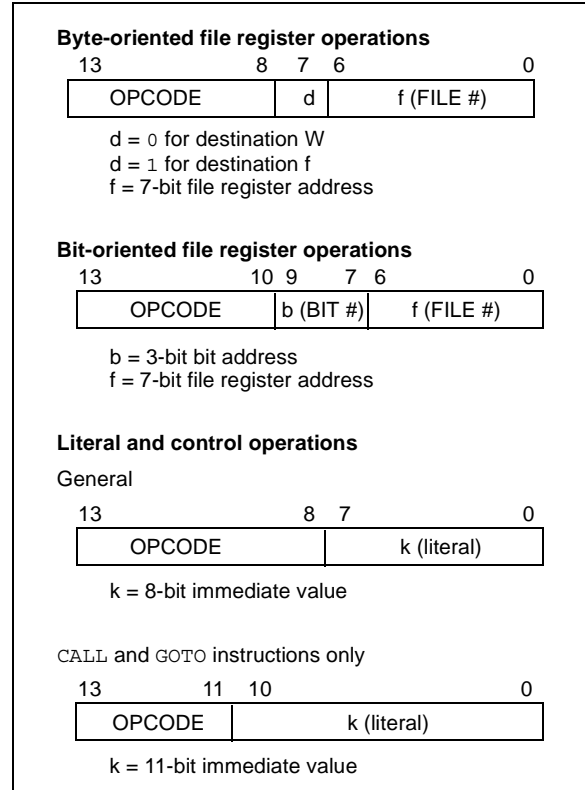## 15.1   READ-MODIFY-WRITE OPERATIONS

Any instruction that specifies a file register as part of the instruction performs a Read-Modify-Write (R-M-W) operation. The register is read, the data is modified, and the result is stored according to either the instruction or the destination designator 'd'. A read operation is performed on a register even if the instruction writes to that register.

For example, a "CLRF   PORTB" instruction will read PORTB, clear all the data bits, then write the result back to PORTB. This example would have the unintended result that the condition that sets the RBIF flag would be cleared.

TABLE 15-1:   OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1). The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1.
PC	Program Counter
TO	Time-out bit
PD	Power-down bit

FIGURE 15-1:   GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations

```
 13          8 7 6              0
 +----------+---+--------------+
 | OPCODE   | d | f (FILE #)   |
 +----------+---+--------------+
```

d = 0 for destination W
d = 1 for destination f
f = 7-bit file register address

Bit-oriented file register operations

```
 13        10 9    7 6          0
 +----------+------+------------+
 | OPCODE   | b (BIT #) | f (FILE #) |
 +----------+------+------------+
```

b = 3-bit bit address
f = 7-bit file register address

Literal and control operations

General
```
 13             8 7             0
 +-------------+---------------+
 | OPCODE      | k (literal)   |
 +-------------+---------------+
```

k = 8-bit immediate value

CALL and GOTO instructions only
```
 13       11 10                0
 +---------+-------------------+
 | OPCODE  | k (literal)       |
 +---------+-------------------+
```

k = 11-bit immediate value

16.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
  - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
  - MPASM™ Assembler
  - MPLAB C17 and MPLAB C18 C Compilers
  - MPLINK™ Object Linker/
    MPLIB™ Object Librarian
  - MPLAB C30 C Compiler
  - MPLAB ASM30 Assembler/Linker/Library
- Simulators
  - MPLAB SIM Software Simulator
  - MPLAB dsPIC30 Software Simulator
- Emulators
  - MPLAB ICE 2000 In-Circuit Emulator
  - MPLAB ICE 4000 In-Circuit Emulator
- In-Circuit Debugger
  - MPLAB ICD 2
- Device Programmers
  - PRO MATE® II Universal Device Programmer
  - PICSTART® Plus Development Programmer
- Low Cost Demonstration Boards
  - PICDEM™ 1 Demonstration Board
  - PICDEM.net™ Demonstration Board
  - PICDEM 2 Plus Demonstration Board
  - PICDEM 3 Demonstration Board
  - PICDEM 4 Demonstration Board
  - PICDEM 17 Demonstration Board
  - PICDEM 18R Demonstration Board
  - PICDEM LIN Demonstration Board
  - PICDEM USB Demonstration Board
- Evaluation Kits
  - KEELOQ®
  - PICDEM MSC
  - microID®
  - CAN
  - PowerSmart®
  - Analog

16.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit micro-controller market. The MPLAB IDE is a Windows® based application that contains:

- An interface to debugging tools
  - simulator
  - programmer (sold separately)
  - emulator (sold separately)
  - in-circuit debugger (sold separately)
- A full-featured editor with color coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High level source code debugging
- Mouse over variable inspection
- Extensive on-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
  - source files (assembly or C)
  - absolute listing file (mixed assembly and C)
  - machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost effective simulators, through low cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increasing flexibility and power.

16.2 MPASM Assembler

The MPASM assembler is a full-featured, universal macro assembler for all PIC MCUs.

The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects
- User defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

17.0   ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Ambient temperature under bias...-55 to +125°C

Storage temperature .... -65°C to +150°C

Voltage on any pin with respect to Vss (except VDD, $\overline{\text{MCLR}}$. and RA4) .... -0.3V to (VDD + 0.3V)

Voltage on VDD with respect to Vss .... -0.3 to +7.5V

Voltage on $\overline{\text{MCLR}}$ with respect to Vss **(Note 2)** ....0 to +14V

Voltage on RA4 with respect to Vss..0 to +8.5V

Total power dissipation **(Note 1)** 1.0W

Maximum current out of Vss pin ....300 mA

Maximum current into VDD pin ....250 mA

Input clamp current, IIK (VI < 0 or VI > VDD)..± 20 mA

Output clamp current, IOK (VO < 0 or VO > VDD) ....± 20 mA

Maximum output current sunk by any I/O pin..25 mA

Maximum output current sourced by any I/O pin ....25 mA

Maximum current sunk by PORTA, PORTB and PORTE (combined) **(Note 3)**...200 mA

Maximum current sourced by PORTA, PORTB and PORTE (combined) **(Note 3)**...200 mA

Maximum current sunk by PORTC and PORTD (combined) **(Note 3)** ....200 mA

Maximum current sourced by PORTC and PORTD (combined) **(Note 3)** ....200 mA

> **Note 1:** Power dissipation is calculated as follows: Pdis = VDD x {IDD - $\sum$ IOH} + $\sum$ {(VDD - VOH) x IOH} + $\sum$(VOl x IOL)
>
> **2:** Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the $\overline{\text{MCLR}}$ pin rather than pulling this pin directly to Vss.
>
> **3:** PORTD and PORTE are not implemented on PIC16F873A/876A devices.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

17.1   DC Characteristics: PIC16F873A/874A/876A/877A (Industrial, Extended)
PIC16LF873A/874A/876A/877A (Industrial)

PIC16LF873A/874A/876A/877A (Industrial)			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
PIC16F873A/874A/876A/877A (Industrial, Extended)			**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param No.	**Symbol**	**Characteristic/ Device**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
	VDD	**Supply Voltage**					
D001		16LF87XA	2.0	—	5.5	V	All configurations (DC to 10 MHz)
D001		16F87XA	4.0	—	5.5	V	All configurations
D001A			VBOR		5.5	V	BOR enabled, FMAX = 14 MHz[7]
D002	VDR	**RAM Data Retention Voltage**[1]	—	1.5	—	V	
D003	VPOR	**VDD Start Voltage** to ensure internal Power-on Reset signal	—	VSS	—	V	See **Section 14.5 "Power-on Reset (POR)"** for details
D004	SVDD	**VDD Rise Rate** to ensure internal Power-on Reset signal	0.05	—	—	V/ms	See **Section 14.5 "Power-on Reset (POR)"** for details
D005	VBOR	**Brown-out Reset Voltage**	3.65	4.0	4.35	V	BODEN bit in configuration word enabled

Legend: Rows with standard voltage device data only are shaded for improved readability.

   †   Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1:   This is the limit to which VDD can be lowered without losing RAM data.

   2:   The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading, switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all IDD measurements in active operation mode are:
            OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;
            MCLR = VDD; WDT enabled/disabled as specified.

   3:   The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD and VSS.

   4:   For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

   5:   Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

   6:   The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

   7:   When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

17.3 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS

2. TppS

3. T$_{CC:ST}$ (I^{2}C specifications only)

4. Ts (I^{2}C specifications only)

T				
F	Frequency		T	Time

Lowercase letters (pp) and their meanings:

pp				
cc	CCP1		osc	OSC1
ck	CLKO		rd	$\overline{RD}$
cs	$\overline{CS}$		rw	$\overline{RD}$ or $\overline{WR}$
di	SDI		sc	SCK
do	SDO		ss	$\overline{SS}$
dt	Data in		t0	T0CKI
io	I/O port		t1	T1CKI
mc	$\overline{MCLR}$		wr	$\overline{WR}$

Uppercase letters and their meanings:

S				
F	Fall		P	Period
H	High		R	Rise
I	Invalid (High-impedance)		V	Valid
L	Low		Z	High-impedance
I^{2}C only				
AA	output access		High	High
BUF	Bus free		Low	Low

T$_{CC:ST}$ (I^{2}C specifications only)

CC				
HD	Hold		SU	Setup
ST				
DAT	Data input hold		STO	Stop condition
STA	Start condition			

FIGURE 17-3: LOAD CONDITIONS

R_L = 464Ω

C_L = 50 pF for all pins except OSC2, but including PORTD and PORTE outputs as ports,

15 pF for OSC2 output

Note: PORTD and PORTE are not implemented on PIC16F873A/876A devices.
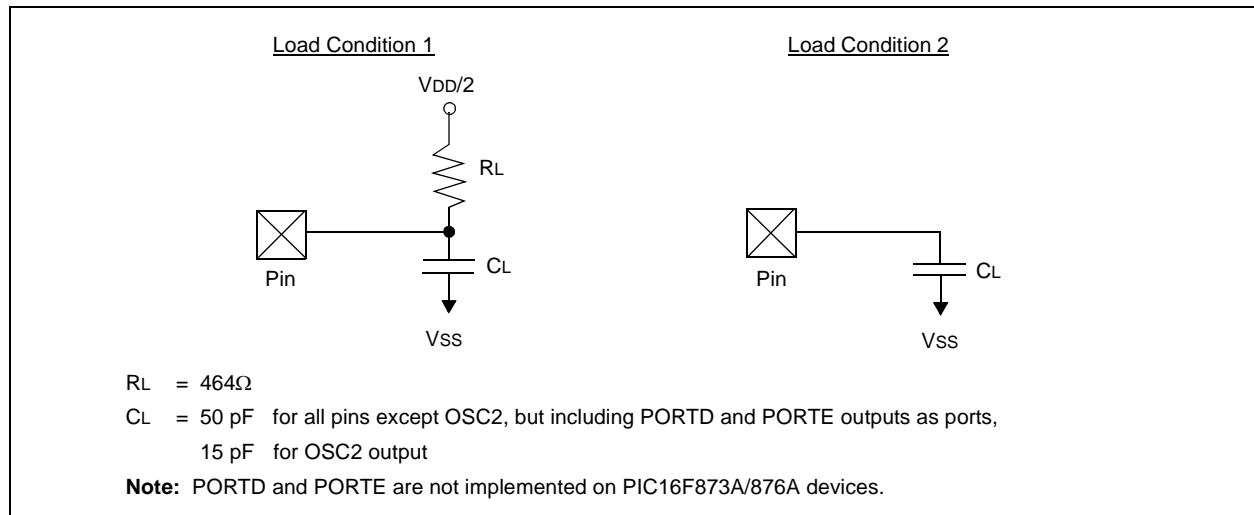
FIGURE 17-17: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

Note: Refer to Figure 17-3 for load conditions.
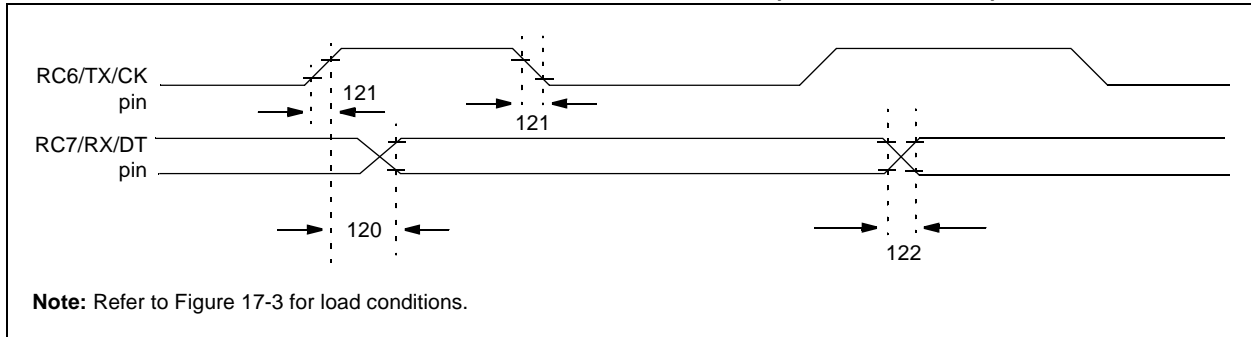
TABLE 17-12: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
120	T$_{CKH2DTV}$	SYNC XMIT (MASTER & SLAVE) Clock High to Data Out Valid	Standard(**F**)	—	—	80	ns	
			Extended(**LF**)	—	—	100	ns	
121	T$_{CKRF}$	Clock Out Rise Time and Fall Time (Master mode)	Standard(**F**)	—	—	45	ns	
			Extended(**LF**)	—	—	50	ns	
122	T$_{DTRF}$	Data Out Rise Time and Fall Time	Standard(**F**)	—	—	45	ns	
			Extended(**LF**)	—	—	50	ns	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-18: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

Note: Refer to Figure 17-3 for load conditions.
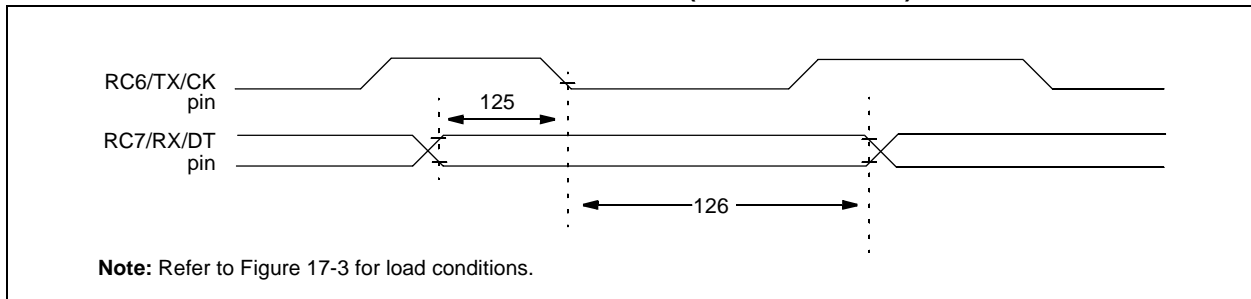
TABLE 17-13: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
125	T$_{DTV2CKL}$	SYNC RCV (MASTER & SLAVE) Data Setup before CK ↓ (DT setup time)	15	—	—	ns	
126	T$_{CKL2DTL}$	Data Hold after CK ↓ (DT hold time)	15	—	—	ns	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16F87XA

FIGURE 18-23: A/D NONLINEARITY vs. VREFH (VDD = VREFH, -40°C TO +125°C)
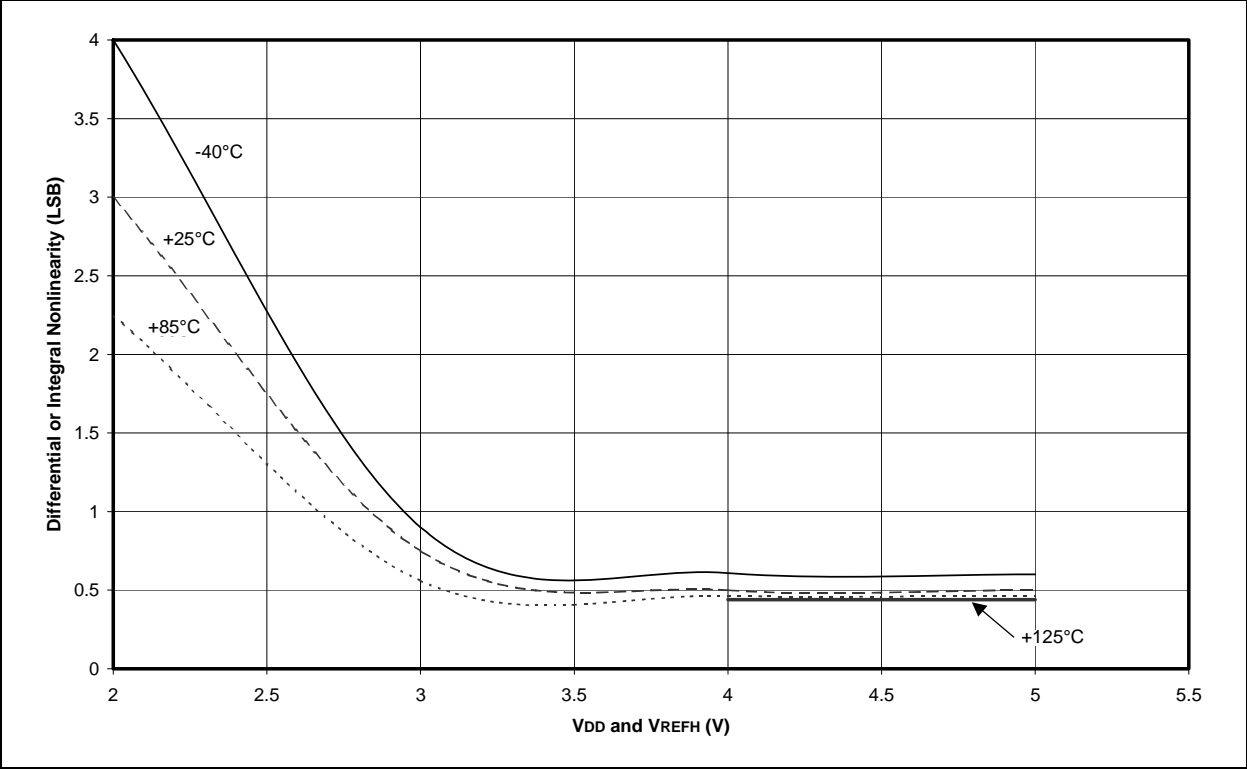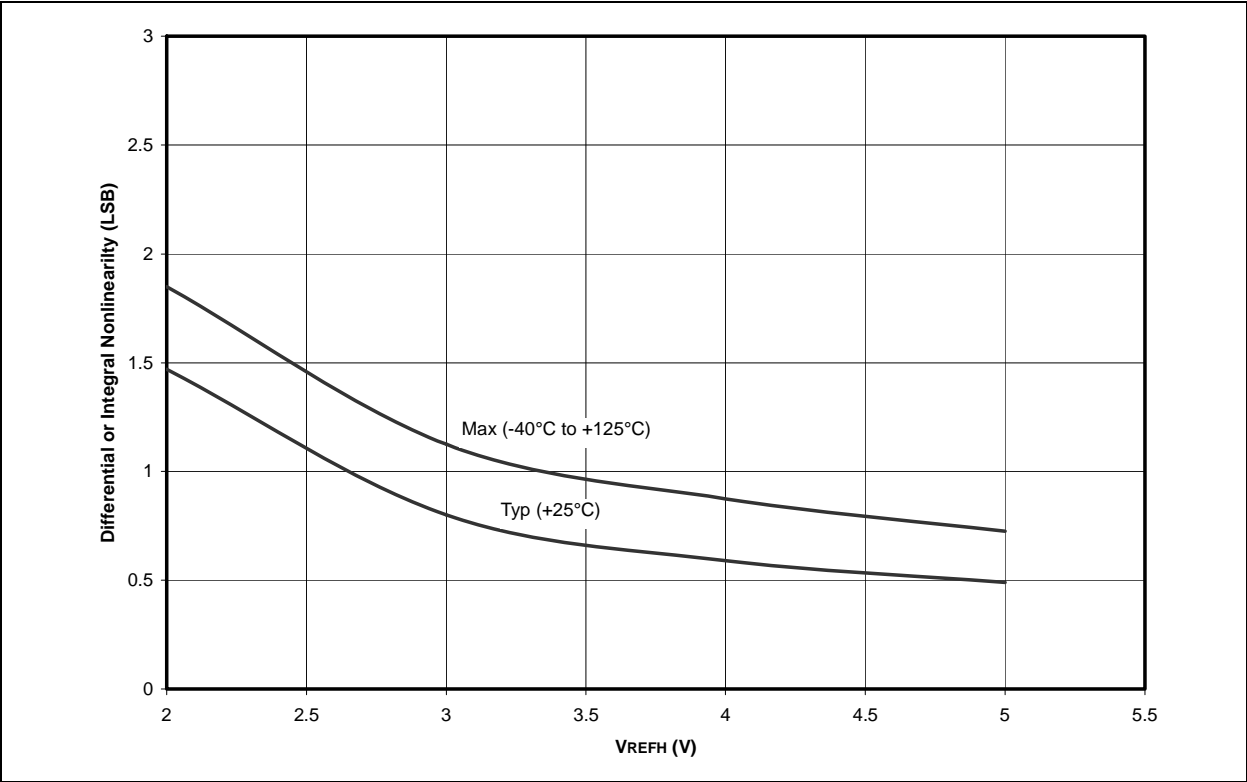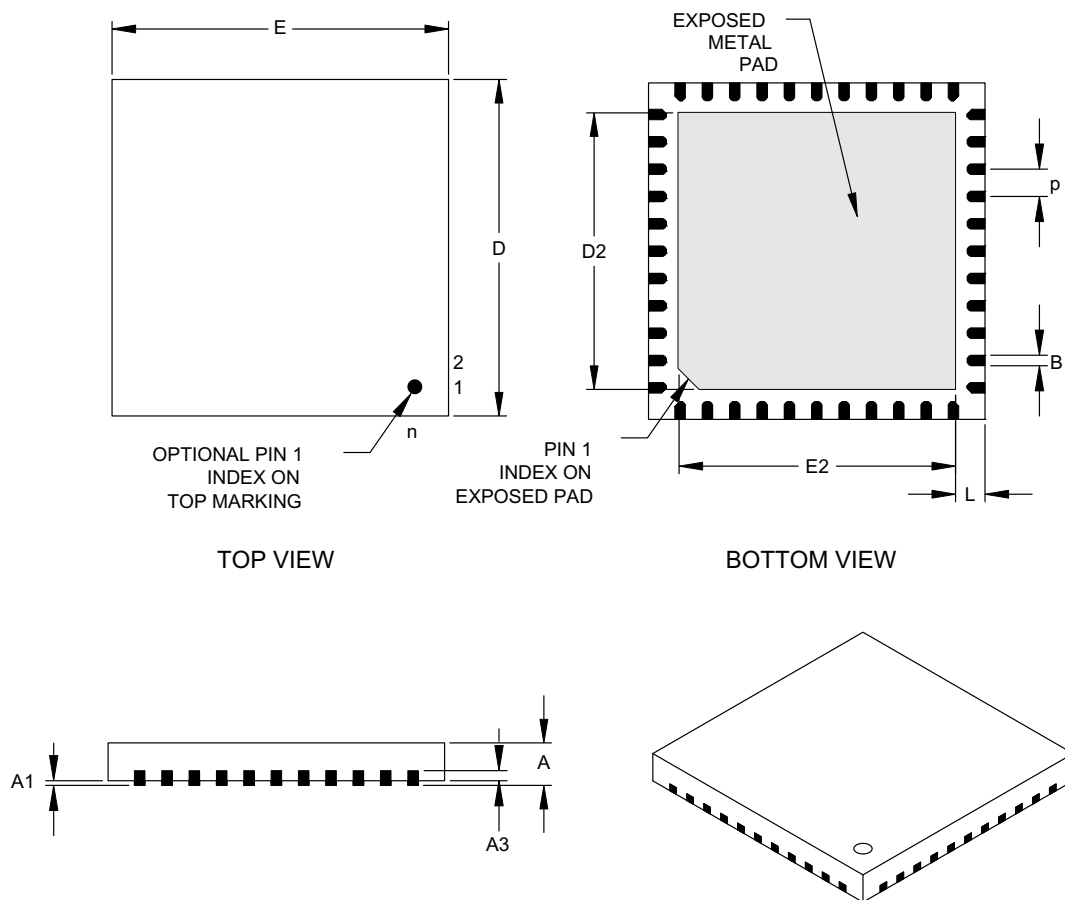

FIGURE 18-24: A/D NONLINEARITY vs. VREFH (VDD = 5V, -40°C TO +125°C)

PIC16F87XA

44-Lead Plastic Quad Flat No Lead Package (ML) 8x8 mm Body (QFN)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

TOP VIEW

BOTTOM VIEW

	Units	INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		44			44	
Pitch	p		.026 BSC			0.65 BSC	
Overall Height	A	.031	.035	.039	0.80	0.90	1.00
Standoff	A1	.000	.001	.002	0	0.02	0.05
Base Thickness	A3		.010 REF			0.25 REF	
Overall Width	E		.315 BSC			8.00 BSC	
Exposed Pad Width	E2	.262	.268	.274	6.65	6.80	6.95
Overall Length	D		.315 BSC			8.00 BSC	
Exposed Pad Length	D2	.262	.268	.274	6.65	6.80	6.95
Lead Width	B	.012	.013	.013	0.30	0.33	0.35
Lead Length	L	.014	.016	.018	0.35	0.40	0.45

*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.
JEDEC equivalent: M0-220

Drawing No. C04-103

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PIC16F87XA

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